

MOSFET

OptiMOS[™] 5 Power-Transistor, 60 V

Features

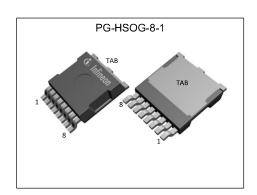
- N-channel
- Superior thermal resistance
- 100% avalanche tested
- Pb-free lead plating; RoHS compliant
 Halogen-free according to IEC61249-2-21

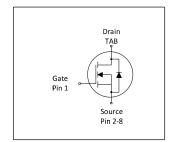
Product validation

Fully qualified according to JEDEC for Industrial Applications

Table 1 **Key Performance Parameters**

rable i Rey i cironnance i diameters							
Parameter	Value	Unit					
$V_{ t DS}$	60	V					
R _{DS(on),max}	0.75	m $Ω$					
I _D	454	A					
$Q_{ m oss}$	219	nC					
Q_{G}	209	nC					











Type / Ordering Code	Package	Marking	Related Links
IPTG007N06NM5	PG-HSOG-8-1	007N06N	-

OptiMOS[™] 5 Power-Transistor, 60 V



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OptiMOS[™] 5 Power-Transistor, 60 V IPTG007N06NM5



1 Maximum ratings at T_A =25 °C, unless otherwise specified

Table 2 Maximum ratings

Davamatar	Sumb al		Values			N
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Continuous drain current ¹⁾	I _D	- - -	- - -	454 349 323 53	A	$V_{\rm GS}$ =10 V, $T_{\rm C}$ =25 °C $V_{\rm GS}$ =10 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =6 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =10 V, $T_{\rm A}$ =25°C, $R_{\rm THJA}$ =40°C/W ²⁾
Pulsed drain current ³⁾	I _{D,pulse}	-	-	1816	Α	<i>T</i> _A =25 °C
Avalanche energy, single pulse ⁴⁾	E _{AS}	-	-	1100	mJ	$I_{\rm D}$ =150 A, $R_{\rm GS}$ =25 Ω
Gate source voltage	V _{GS}	-20	-	20	V	-
Power dissipation	P _{tot}	-	-	375 3.8	W	T _C =25 °C T _A =25 °C, R _{THJA} =40 °C/W ²⁾
Operating and storage temperature	T _j , T _{stg}	-55	-	175	°C	IEC climatic category; DIN IEC 68-1 55/175/56

2 Thermal characteristics

Table 3 Thermal characteristics

Parameter	Symbol	Values			Unit	Note / Test Condition
raiailletei	Symbol	Min.	Typ.	Max.	Oilit	Note / Test Condition
Thermal resistance, junction - case	R_{thJC}	-	0.2	0.4	°C/W	-
Thermal resistance, junction - ambient, 6 cm² cooling area		-	_	40	°C/W	-
Thermal resistance, junction - ambient, minimal footprint ²⁾	R _{thJA}	-	-	62	°C/W	-

¹⁾ Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature environmental conditions.

2) Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm² (one layer, 70 µm thick) copper area for drain connection. PCB is vertical in still air.

3) See Diagram 3 for more detailed in as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual

See Diagram 3 for more detailed information

⁴⁾ See Diagram 13 for more detailed information

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3 Electrical characteristics at T_j =25 °C, unless otherwise specified

Table 4 **Static characteristics**

Parameter	Cruss Is a I		Values			Nata / Taat Can dition
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source breakdown voltage	V _{(BR)DSS}	60	-	-	V	V _{GS} =0 V, I _D =1 mA
Gate threshold voltage	$V_{\rm GS(th)}$	2.1	2.8	3.3	V	V _{DS} =V _{GS} , I _D =280 μA
Zero gate voltage drain current	I _{DSS}	-	0.1 10	1 100	μA	V _{DS} =60 V, V _{GS} =0 V, T _j =25 °C V _{DS} =60 V, V _{GS} =0 V, T _j =125 °C
Gate-source leakage current	I _{GSS}	-	10	100	nA	V _{GS} =20 V, V _{DS} =0 V
Drain-source on-state resistance	R _{DS(on)}	-	0.68 0.87	0.75 1.0	mΩ	V _{GS} =10 V, I _D =150 A V _{GS} =6 V, I _D =75 A
Gate resistance ¹⁾	R _G	-	1.8	2.7	Ω	-
Transconductance	g_{fs}	160	320	-	S	

 Table 5
 Dynamic characteristics

Parameter	S. mahal	Values			Unit	Note / Test Condition
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance ¹⁾	Ciss	-	16000	21000	pF	V _{GS} =0 V, V _{DS} =30 V, f=1 MHz
Output capacitance ¹⁾	Coss	-	3100	4000	pF	V _{GS} =0 V, V _{DS} =30 V, f=1 MHz
Reverse transfer capacitance ¹⁾	C _{rss}	-	200	350	pF	V _{GS} =0 V, V _{DS} =30 V, f=1 MHz
Turn-on delay time	$t_{\sf d(on)}$	-	38	-	ns	$V_{\rm DD} = 30 \text{ V}, V_{\rm GS} = 10 \text{ V}, I_{\rm D} = 100 \text{ A}, R_{\rm G,ext} = 1.8 \Omega$
Rise time	t _r	-	18	-	ns	$V_{\rm DD} = 30 \text{ V}, V_{\rm GS} = 10 \text{ V}, I_{\rm D} = 100 \text{ A}, R_{\rm G,ext} = 1.8 \Omega$
Turn-off delay time	$t_{ m d(off)}$	_	76	-	ns	$V_{\rm DD} = 30 \text{ V}, V_{\rm GS} = 10 \text{ V}, I_{\rm D} = 100 \text{ A}, R_{\rm G,ext} = 1.8 \Omega$
Fall time	t _f	-	22	-	ns	$V_{\rm DD} = 30 \text{ V}, V_{\rm GS} = 10 \text{ V}, I_{\rm D} = 100 \text{ A}, R_{\rm G,ext} = 1.8 \Omega$

Gate charge characteristics²⁾ Table 6

Parameter	Cymah al	Values			11!4	Nata / Tank Oan little
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge	Q _{gs}	-	67	-	nC	V_{DD} =30 V, I_{D} =100 A, V_{GS} =0 to 10 V
Gate charge at threshold	Q _{g(th)}	-	44	-	nC	V_{DD} =30 V, I_{D} =100 A, V_{GS} =0 to 10 V
Gate to drain charge ¹⁾	Q_{gd}	-	35	53	nC	V_{DD} =30 V, I_{D} =100 A, V_{GS} =0 to 10 V
Switching charge	Q _{sw}	-	57	-	nC	V_{DD} =30 V, I_{D} =100 A, V_{GS} =0 to 10 V
Gate charge total ¹⁾	Q_{g}	-	209	261	nC	V_{DD} =30 V, I_{D} =100 A, V_{GS} =0 to 10 V
Gate plateau voltage	V _{plateau}	-	4.2	-	V	V_{DD} =30 V, I_{D} =100 A, V_{GS} =0 to 10 V
Output charge ¹⁾	Qoss	-	219	291	nC	V _{DS} =30 V, V _{GS} =0 V

Defined by design. Not subject to production test.
See "Gate charge waveforms" for parameter definition

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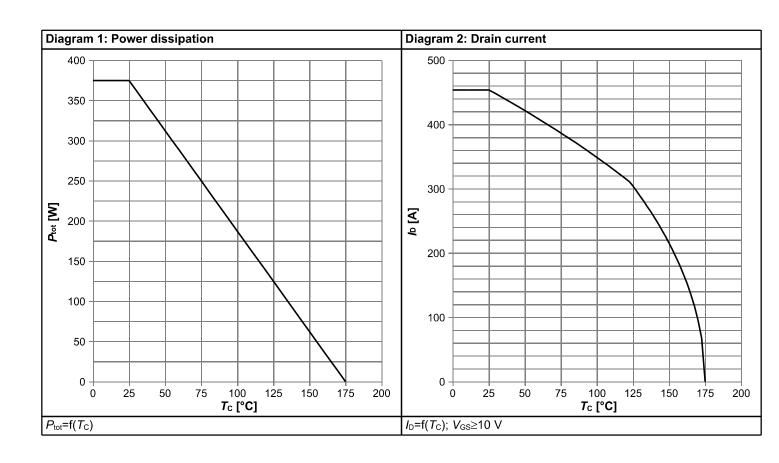


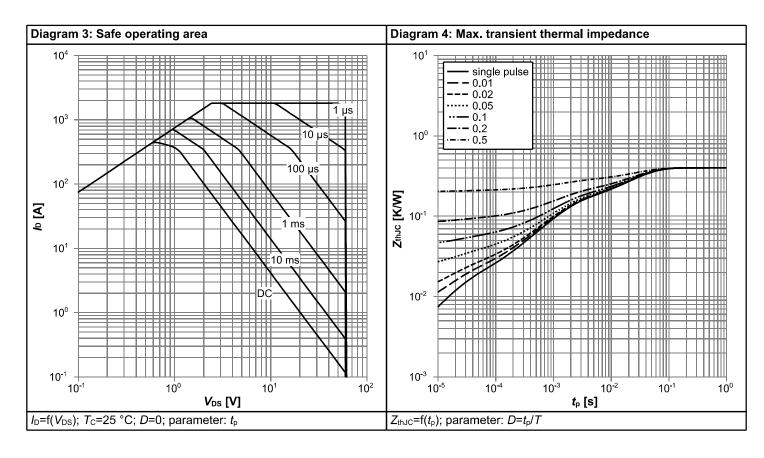
Table 7 Reverse diode

Parameter	Currele el		Values			Note / Tool Occupies
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Diode continuous forward current	I _S	-	-	316	Α	T _C =25 °C
Diode pulse current	I _{S,pulse}	-	-	1816	Α	T _C =25 °C
Diode forward voltage	V _{SD}	-	0.87	1	V	V _{GS} =0 V, I _F =150 A, T _j =25 °C
Reverse recovery time ¹⁾	t _{rr}	-	87	174	ns	V _R =30 V, I _F =100 A, di _F /dt=100 A/μs
Reverse recovery charge ¹⁾	Qrr	-	144	-	nC	V _R =30 V, I _F =100 A, d <i>i</i> _F /d <i>t</i> =100 A/μs

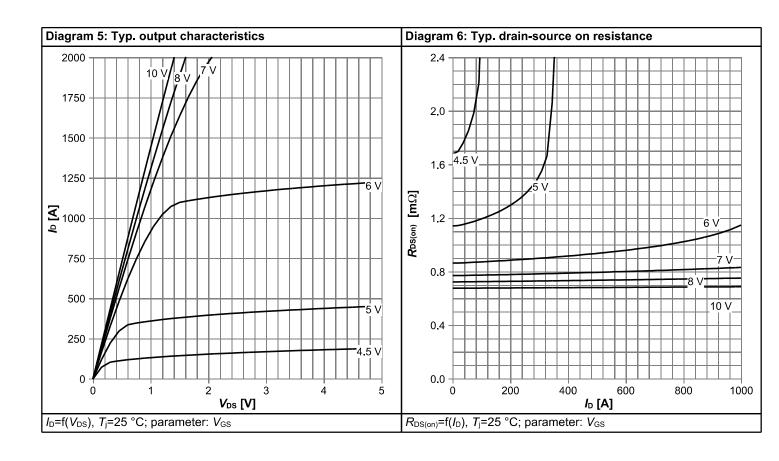


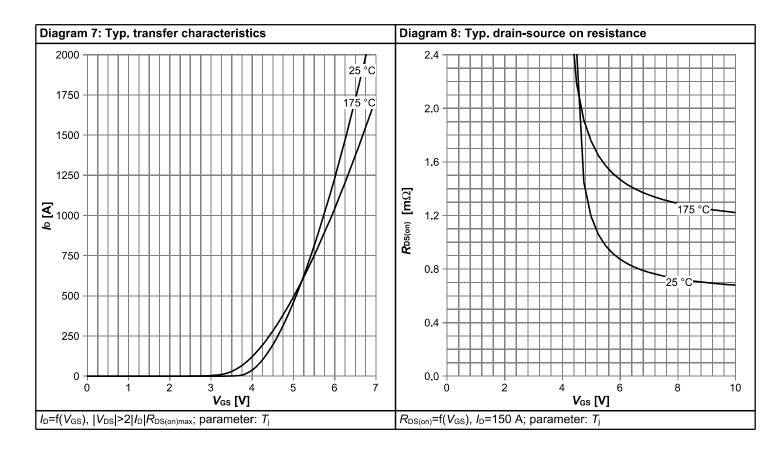
4 Electrical characteristics diagrams



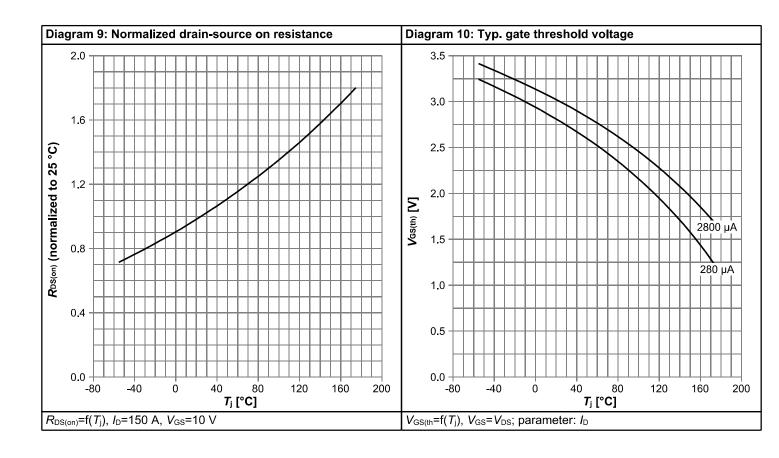


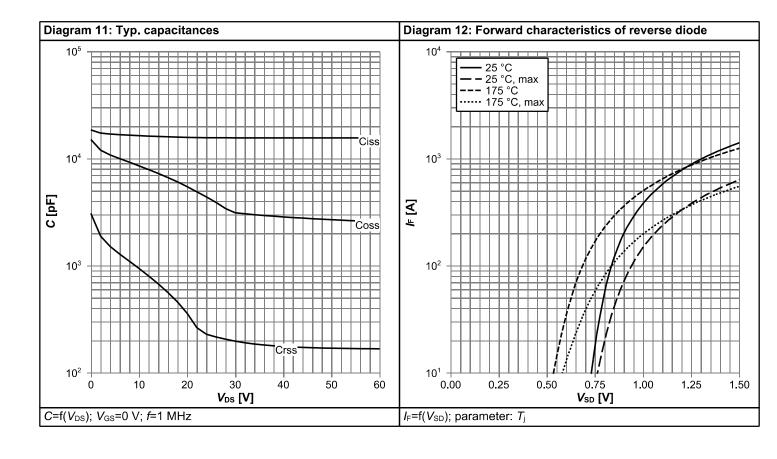




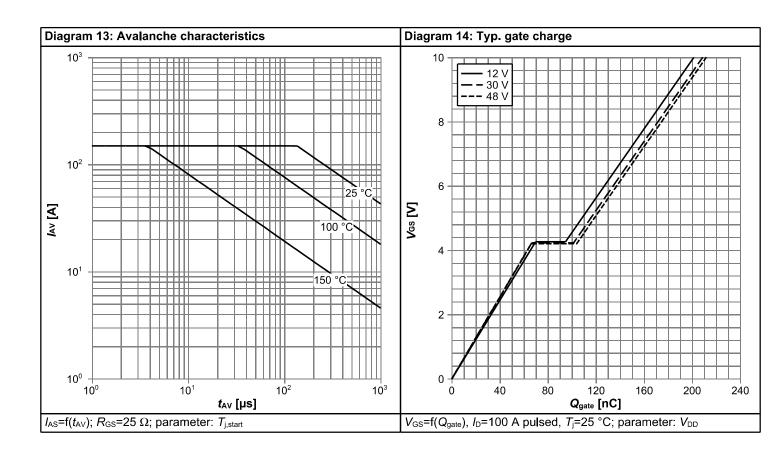


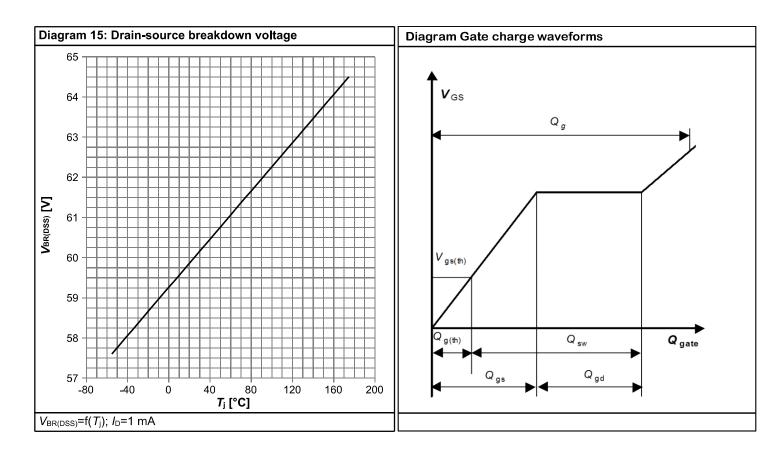






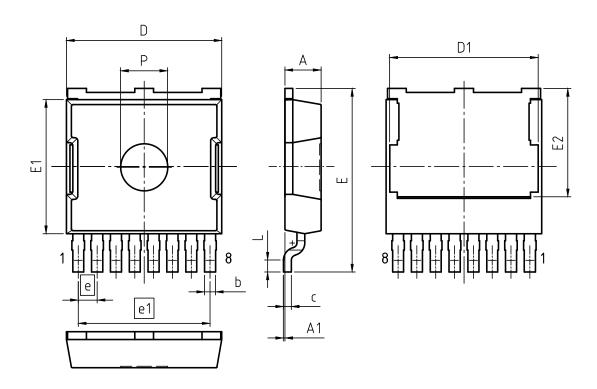








5 Package Outlines



PACKAGE - GROUP NUMBER:	PG-HS	PG-HSOG-8-U01				
REVISION: 01	DATE	: 08.02.2021				
DIMENSIONS	MILLI	METERS				
DIMENSIONS	MIN.	MAX.				
Α	2.20	2.40				
A1	0.00	0.10				
b	0.60	0.80				
С	0.40	0.60				
D	9.70	10.10				
D1	9.36	9.56				
E	11.50	11.90				
E1	8.45	8.75				
E2	6.81	7.01				
е	1	.20				
e1	8	3.40				
L	0.66	0.86				
P	2.90	3.10				

Figure 1 Outline PG-HSOG-8-1, dimensions in mm

OptiMOS[™] 5 Power-Transistor, 60 V



Revision History

IPTG007N06NM5

Revision: 2021-04-22, Rev. 2.1

Previous Revision

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Revision	Revision Date Subjects (major changes since last revision)					
2.0	2021-02-11	Release of final version				
2.1	2021-04-22	Update capacitances and gate charges				

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